20 V, 2 A very low V_F MEGA Schottky barrier rectifiers Rev. 04 — 15 January 2010 Product d

Product data sheet

Product profile 1.

1.1 General description

Planar Maximum Efficiency General Application (MEGA) Schottky barrier rectifiers with an integrated guard ring for stress protection, encapsulated in small and flat lead Surface Mounted Device (SMD) plastic packages.

Table 1. **Product overview**

Type number	Package		Configuration
	NXP	JEITA	
PMEG2020EH	SOD123F	-	single diode
PMEG2020EJ	SOD323F	SC-90	single diode

1.2 Features

- Forward current: 2 A
- Reverse voltage: 20 V
- Very low forward voltage
- Small and flat lead SMD plastic package

1.3 Applications

- Low voltage rectification
- High efficiency DC-to-DC conversion
- Switch mode power supply
- Inverse polarity protection
- Low power consumption applications

1.4 Quick reference data

Table 2. Quick reference data

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
I _F	forward current	$T_{sp} \le 55 \ ^{\circ}C$	-	-	2	А
V _R	reverse voltage		-	-	20	V
V _F	forward voltage	I _F = 2 A	<u>[1]</u> _	450	525	mV

[1] Pulse test: $t_p \le 300 \ \mu s$; $\delta \le 0.02$.



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2. Pinning information

Pin	Description	Simplified outline Symbol
1	cathode	[1]
2	anode	1 2 sym001

[1] The marking bar indicates the cathode.

3. Ordering information

Table 4. Order	ing informati	on	
Type number	Package		
	Name	Description	Version
PMEG2020EH	-	plastic surface mounted package; 2 leads	SOD123F
PMEG2020EJ	SC-90	plastic surface mounted package; 2 leads	SOD323F

4. Marking

Table 5. Marking codes	
Type number	Marking code
PMEG2020EH	A6
PMEG2020EJ	СА

5. Limiting values

Symbol	Parameter	Conditions	Min	Max	Unit
V _R	reverse voltage		-	20	V
l _F	forward current	$T_{sp} \le 55 \ ^{\circ}C$	-	2	А
I _{FRM}	repetitive peak forward current	$t_p \leq 1 \text{ ms; } \delta \leq 0.5$	-	7	А
I _{FSM}	non-repetitive peak forward current	t _p = 8 ms; square wave	-	9	A
P _{tot}	total power dissipation	$T_{amb} \le 25 \ ^\circ C$			
	PMEG2020EH		<u>[1]</u> _	375	mW
			[2]	830	mW
	PMEG2020EJ		<u>[1]</u> _	360	mW
			[2]	830	mW
Tj	junction temperature		-	150	°C
T _{amb}	ambient temperature		-65	+150	°C
T _{stg}	storage temperature		-65	+150	°C

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm².

6. Thermal characteristics

Table 7.	Thermal characteristics					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
R _{th(j-a)}	thermal resistance from junction to ambient	in free air				
	PMEG2020EH		<u>[1][2]</u> _	-	330	K/W
			<u>[1][3]</u>	-	150	K/W
	PMEG2020EJ		<u>[1][2]</u> _	-	350	K/W
			<u>[1][3]</u>	-	150	K/W
R _{th(j-sp)}	thermal resistance from junction to solder point		[4]			
	PMEG2020EH		-	-	60	K/W
	PMEG2020EJ		-	-	55	K/W

[1] For Schottky barrier diodes thermal run-away has to be considered, as in some applications the reverse power losses P_R are a significant part of the total power losses. Nomograms for determining the reverse power losses P_R and $I_{F(AV)}$ rating will be available on request.

- [2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.
- [3] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm².
- [4] Soldering point of cathode tab.

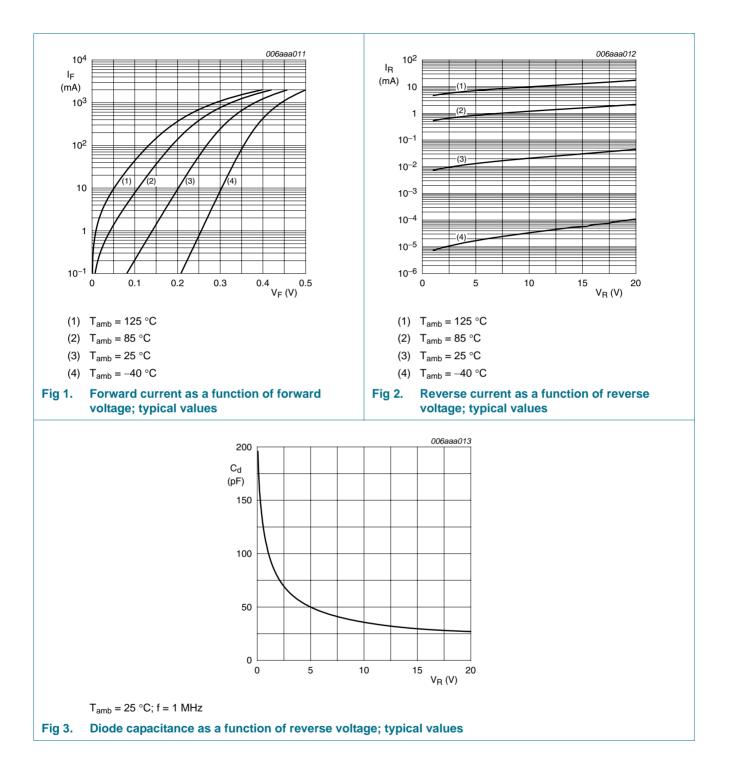
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7. Characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _F	forward voltage		<u>[1]</u>			
		I _F = 0.01 A	-	200	220	mV
		I _F = 0.1 A	-	260	290	mV
		I _F = 1 A	-	370	430	mV
		I _F = 2 A	-	450	525	mV
I _R	reverse current					
		V _R = 5 V	-	15	50	μA
		V _R = 10 V	-	20	80	μA
		V _R = 20 V	-	45	200	μA
C _d	diode capacitance	V _R = 5 V; f = 1 MHz	-	50	60	pF

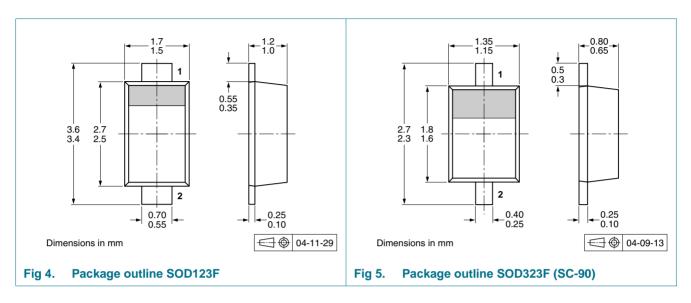
[1] Pulse test: $t_p \le 300 \ \mu s; \delta \le 0.02$.

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8. Package outline



9. Packing information

Table 9. Packing methods

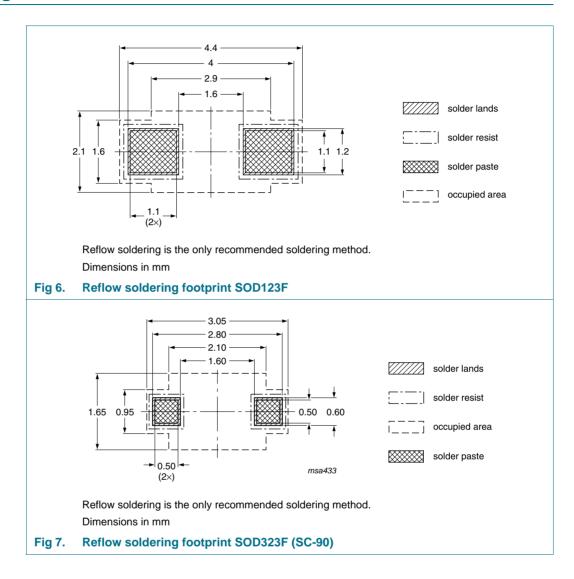
The -xxx numbers are the last three digits of the 12NC ordering code.[1]

Type number	Package	Description	Packing	quantity
			3000	10000
PMEG2020EH	SOD123F	4 mm pitch, 8 mm tape and reel	-115	-135
PMEG2020EJ	SOD323F			

[1] For further information and the availability of packing methods, see <u>Section 13</u>.

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10. Soldering



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11. Revision history

ory			
Release date	Data sheet status	Change notice	Supersedes
20100115	Product data sheet	-	PMEG2020EH_EJ_3
20050810	Product data sheet	-	PMEG2020EH_2 PMEG2020EJ_2
20050523	Product data sheet	-	PMEG2020EH_1
20050304	Preliminary data sheet	-	-
20050131	Product data sheet	-	PMEG2020EJ_1
20040830	Preliminary data sheet	-	-
	Release date 20100115 • This data sheet including new lease ontent. 20050810 20050523 20050304 20050131	Release dateData sheet status20100115Product data sheet• This data sheet was changed to reflect the including new legal definitions and disclair content.20050810Product data sheet20050523Product data sheet20050304Preliminary data sheet20050131Product data sheet	Release dateData sheet statusChange notice20100115Product data sheet-• This data sheet was changed to reflect the new company name including new legal definitions and disclaimers. No changes we content20050810Product data sheet-20050523Product data sheet-20050304Preliminary data sheet-20050131Product data sheet-

12. Legal information

12.1 Data sheet status

Document status ^{[1][2]}	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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